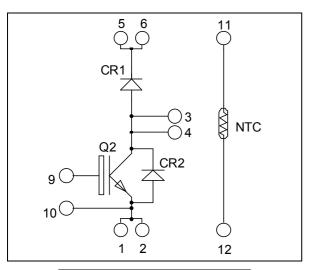
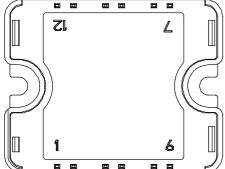


Boost chopper NPT IGBT Power Module

$$V_{CES} = 1200V$$

 $I_C = 75A$ @ $Tc = 80$ °C





Pins 1/2; 3/4; 5/6 must be shorted together

Application

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

Features

- Non Punch Through (NPT) Fast IGBT
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 50 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - RBSOA and SCSOA rated
- Very low stray inductance
- Internal thermistor for temperature monitoring
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage		1200	V
I_{C}	Continuous Collector Current	$T_c = 25^{\circ}C$	100	
1 _C	Continuous Conector Current	$T_c = 80^{\circ}C$	75	A
I_{CM}	Pulsed Collector Current	$T_c = 25^{\circ}C$	150	
V_{GE}	Gate – Emitter Voltage		±20	V
P_{D}	Maximum Power Dissipation	$T_c = 25^{\circ}C$	500	W
RBSOA	Reverse Bias Safe Operating Area	$T_j = 150^{\circ}C$	150A @ 1200V	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



All ratings @ $T_j = 25$ °C unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
Ţ	Zero Gate Voltage Collector Current	$V_{GE} = 0V$	$T_j = 25$ °C			250	4
l_{CES}	Zero Gate Voltage Collector Current	$V_{CE} = 1200V$	$T_j = 125$ °C			500	μΑ
V	Collector Emitter saturation Voltage	$V_{GE} = 15V$	$T_j = 25$ °C		3.2	3.7	V
$V_{CE(sat)}$	Collector Emitter saturation voltage	$I_C = 75A$	$T_j = 125$ °C		3.9		v
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_{C} = 2.5 \text{ mA}$		4.5		6.5	V
I_{GES}	Gate – Emitter Leakage Current	$V_{GE} = \pm 20V, V_{CE} = 0V$				±500	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
Cies	Input Capacitance	$V_{GE} = 0V$			5.1		
C_{oes}	Output Capacitance	$V_{CE} = 25V$	$V_{CE} = 25V$		0.7		nF
C_{res}	Reverse Transfer Capacitance	f = 1MHz			0.4		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switch	ning (25°C)		120		ns
T_{r}	Rise Time	$V_{GE} = 15V$			50		
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 600V$ $I_{C} = 75A$			310		
T_{f}	Fall Time	$R_G = 7.5\Omega$		20			
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C) $V_{GE} = 15V$ $V_{Bus} = 600V$ $I_{C} = 75A$ $R_{G} = 7.5\Omega$			130		ns
T_{r}	Rise Time				60		
$T_{d(off)}$	Turn-off Delay Time				360		
T_{f}	Fall Time				30		
Eon	Turn-on Switching Energy	$V_{GE} = 15V$ $V_{Bus} = 600V$	$T_j = 125$ °C		9		I ees
E_{off}	Turn-off Switching Energy	$I_C = 75A$ $R_G = 7.5\Omega$	$T_j = 125^{\circ}C$		4		mJ

Chopper diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
V_{RRM}	Maximum Peak Repetitive Reverse Voltage			1200			V
I_{RM}	Maximum Reverse Leakage Current	$V_{R}=1200V$	$T_j = 25^{\circ}C$			100	μA
*KWI	Transman reverse Boarage Carrent	VR 1200 V	$T_j = 125$ °C			500	μπ
I_F	DC Forward Current		$Tc = 70^{\circ}C$		60		A
	Diode Forward Voltage	$I_F = 60A$			2.5	3	
$V_{\rm F}$		$I_F = 120A$			3		V
		$I_F = 60A$	$T_j = 125$ °C		1.8		
t	Reverse Recovery Time	$I_F = 60A$ $V_R = 800V$	$T_j = 25$ °C		265		ns
t_{rr}			$T_{j} = 125^{\circ}C$		350		115
Qrr	Reverse Recovery Charge	$di/dt = 200A/\mu s$	$T_j = 25$ °C		560		nC
			$T_{j} = 125^{\circ}C$		2890		

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Thermal and package characteristics

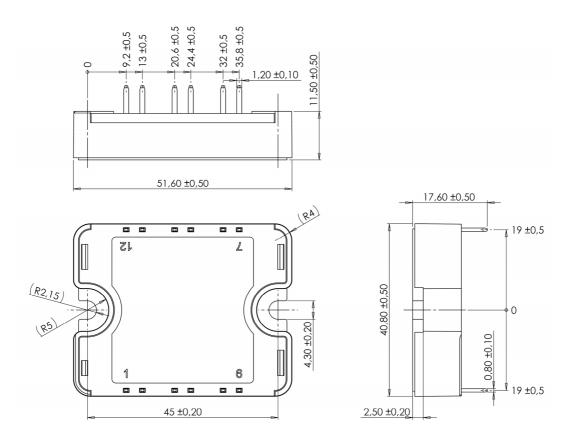
Symbol	Characteristic			Min	Тур	Max	Unit
R_{thJC}	Junction to Case Thermal Resistance		IGBT		0.25	°C/W	
KthJC		Diode			0.9	C/ W	
V_{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
T_{J}	Operating junction temperature range			-40		150	
T_{STG}	Storage Temperature Range		-40		125	°C	
$T_{\rm C}$	Operating Case Temperature					100	
Torque	Mounting torque	To heatsin	ık M4	2		3	N.m
Wt	Package Weight				80	g	

Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

Symbol	Characteristic	Min	Typ	Max	Unit
R ₂₅	Resistance @ 25°C		50		kΩ
B 25/85	$T_{25} = 298.15 \text{ K}$		3952		K

$$R_T = \frac{R_{25}}{\exp \left[B_{25/85} \left(\frac{1}{T_{25}} - \frac{1}{T} \right) \right]} \quad \text{T: Thermistor temperature} \\ R_T: \text{ Thermistor value at T}$$

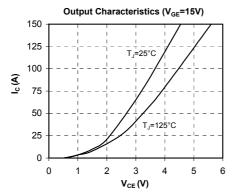
SP1 Package outline (dimensions in mm)

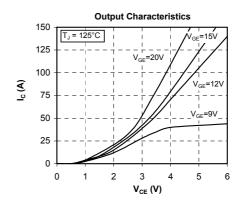


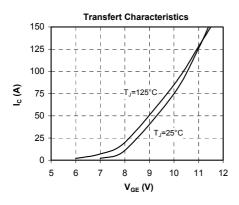
See application note 1904 - Mounting Instructions for SP1 Power Modules on www.microsemi.com

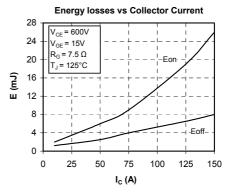


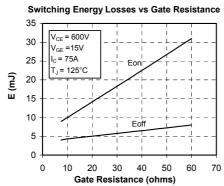
Typical Performance Curve

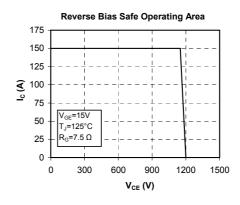


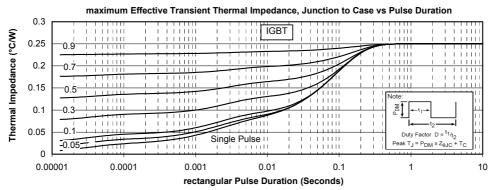






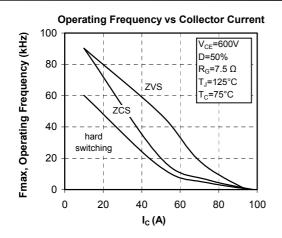


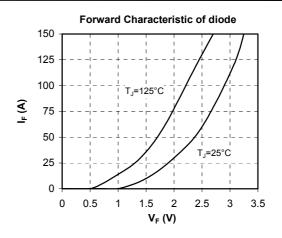


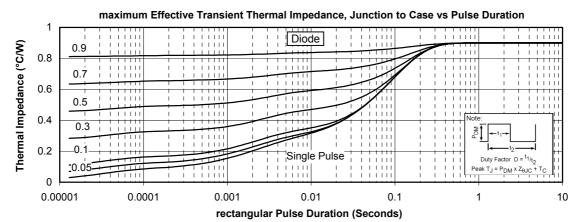


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